



Film Capacitors

EMI Suppression Capacitors (MKP)

Series/Type: B32921C/D ... B32928C/D

Date: September 2019

Typical applications

- X2 class for interference suppression
- "Across the line" applications

Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1:2013):
40/105/56 (ENEC10)
40/110/56 (ENEC15)

Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Very small dimensions
- Self-healing properties
- RoHS-compatible
- Halogen-free capacitors available on request

Terminals

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

Marking

Manufacturer's logo, lot number, date code, rated capacitance (coded), cap. tolerance (code letter), rated AC voltage, series number, sub-class (X2), dielectric code (MKP), climatic category, passive flammability category, approvals.

Delivery mode

Bulk (untaped)
Taped (Ammo pack or reel)
For taping details, refer to chapter "Taping and packing"

Dimensional drawings

Drawing 1



Drawing 2



Dimensions in mm

$P_1 = 20.3 \text{ mm}$

| Lead spacing $e \pm 0.4$ | Lead diameter $d_1 \pm 0.05$ | Type | Drawing |
|-----------------------------|---------------------------------|--------|---------------------|
| 10 | 0.6 | B32921 | 1 |
| 15 | 0.8 | B32922 | 1 |
| 22.5 | 0.8 | B32923 | 1 |
| 27.5 | 0.8 | B32924 | 1 |
| 37.5 | 1.0 | B32926 | 1 / 2 ¹⁾ |
| 52.5 | 1.2 | B32928 | 2 |

1) A few individual types only

B32921C/D ... B32928C/D

X2 / 305 V AC



Marking Examples

C ≤ 10 μF



KMK1541-3

C > 10 μF



KMK1542-2

Approvals

| Approval marks | Standards | Certificate |
|----------------|--|---|
| | EN 60384-14:2014 IEC 60384-14:2013 | 40010694 (approved by VDE) (C ≤ 10 μF) |
| | EN 60384-14:2014 IEC 60384-14:2013 | E97863 (approved by UL) |
| | UL 1414:2000 UL 1283:2005 | E97863 / E157153 |
| | CSA C22.2 No.1:2004 CSA C22.2 No.8:2013 | E97863 / E157153 (approved by UL) |
| | CQC (GB/T 14472-1998):1998 | CQC06001015331 / CQC06001016454 (C ≤ 10 μF) |
| | UL 60384-14:2014 CSA E60384-14:2013 | E97863 (approved by UL) |

Notes:

Effective January 2014, only for EMI suppression capacitors:

- UL 60384-14:2014 certification replaces both UL 1414:2000 and UL 1283:2005 standards.
- CSA C22.2 No.1.2004 and CSA C22.2 No.8:2013 are replaced by CSA E60384-14:2013.
- References like 1414, 1283 are removed from the capacitor marking.

Capacitors under UL 1414:2000, UL 1283:2005 produced during or before 2013, are accepted under UL scope.

Capacitors under CSA C22.2 No.1:2004 / CSA C22.2 No.8:2013 produced during or before 2013, are accepted under cUL scope.



B32921C/D ... B32928C/D

X2 / 305 V AC

Overview of available types

| Lead spacing | 10 mm | 15 mm | 22.5 mm | 27.5 mm | 37.5 mm | 52.5 mm |
|------------------|-----------|-----------|-----------|-----------|-----------|-----------|
| Type | B32921C/D | B32922C/D | B32923C/D | B32924C/D | B32926C/D | B32928C/D |
| C_R (μ F) | | | | | | |
| 0.010 | | | | | | |
| 0.022 | | | | | | |
| 0.033 | | | | | | |
| 0.047 | | | | | | |
| 0.068 | | | | | | |
| 0.10 | | | | | | |
| 0.15 | | | | | | |
| 0.22 | | | | | | |
| 0.33 | | | | | | |
| 0.47 | | | | | | |
| 0.68 | | | | | | |
| 1.0 | | | | | | |
| 1.5 | | | | | | |
| 2.2 | | | | | | |
| 3.3 | | | | | | |
| 3.9 | | | | | | |
| 4.7 | | | | | | |
| 5.6 | | | | | | |
| 6.8 | | | | | | |
| 8.2 | | | | | | |
| 10 | | | | | | |
| 15 | | | | | | |
| 20 | | | | | | |
| 25 | | | | | | |
| 30 | | | | | | |

B32921C/D

X2 / 305 V AC



Ordering codes and packing units (lead spacing 10.0 mm)

| C _R μF | Max. dimensions w × h × l mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./MOQ | Untaped pcs./MOQ | Pins |
|----------------------|------------------------------------|--|-----------------------|------------------|---------------------|------|
| 0.010 | 4.0 × 9.0 × 13.0 | B32921C3103+*** ◆ | 4000 | 6800 | 4000 | 2 |
| 0.022 | 4.0 × 9.0 × 13.0 | B32921C3223+*** ◆ | 4000 | 6800 | 4000 | 2 |
| 0.033 | 4.0 × 9.0 × 13.0 | B32921C3333+*** ◆ | 4000 | 6800 | 4000 | 2 |
| 0.047 | 5.0 × 11.0 × 13.0 | B32921C3473+*** ◆ | 3320 | 5200 | 4000 | 2 |
| 0.068 | 6.0 × 12.0 × 13.0 | B32921C3683+*** | 2720 | 4400 | 4000 | 2 |
| 0.10 | 6.0 × 12.0 × 13.0 | B32921C3104M*** | 2720 | 4400 | 4000 | 2 |

◆ Preferred type

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped
(lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped
(lead length 6 – 1 mm)



B32922C/D

X2 / 305 V AC

Ordering codes and packing units (lead spacing 15.0 mm)

| C _R μF | Max. dimensions w × h × l mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./MOQ | Untaped pcs./MOQ | Pins |
|----------------------|------------------------------------|--|-----------------------|------------------|---------------------|------|
| 0.033 | 5.0 × 10.5 × 18.0 | B32922C3333K*** | 4680 | 5200 | 4000 | 2 |
| 0.047 | 5.0 × 10.5 × 18.0 | B32922C3473K*** | 4680 | 5200 | 4000 | 2 |
| 0.068 | 5.0 × 10.5 × 18.0 | B32922C3683K*** ◆ | 4680 | 5200 | 4000 | 2 |
| 0.10 | 5.0 × 10.5 × 18.0 | B32922C3104+*** ◆ | 4680 | 5200 | 4000 | 2 |
| 0.15 | 6.0 × 12.0 × 18.0 | B32922C3154+*** ◆ | 3840 | 4400 | 4000 | 2 |
| 0.22 | 7.0 × 12.5 × 18.0 | B32922C3224+*** ◆ | 3320 | 3600 | 4000 | 2 |
| 0.33 | 8.0 × 14.0 × 18.0 | B32922C3334M*** ◆ | 2920 | 3000 | 2000 | 2 |
| 0.33 | 8.5 × 14.5 × 18.0 | B32922D3334K*** | 2720 | 2800 | 2000 | 2 |
| 0.47 | 9.0 × 17.5 × 18.0 | B32922C3474+*** ◆ | 2560 | 2800 | 2000 | 2 |
| 0.68 | 11.0 × 18.5 × 18.0 | B32922C3684+*** ◆ | — | 2200 | 1200 | 2 |

◆ Preferred type

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped
(lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped
(lead length 6 – 1 mm)

B32923C/D

X2 / 305 V AC



Ordering codes and packing units (lead spacing 22.5 mm)

| C _R | Max. dimensions w × h × l mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./MOQ | Untaped pcs./MOQ | Pins |
|----------------|------------------------------------|--|-----------------------|------------------|---------------------|------|
| 0.22 | 6.0 × 15.0 × 26.5 | B32923C3224+*** | 2720 | 2800 | 2880 | 2 |
| 0.33 | 6.0 × 15.0 × 26.5 | B32923C3334M*** | 2720 | 2800 | 2880 | 2 |
| 0.33 | 7.0 × 16.0 × 26.5 | B32923D3334K*** | 2320 | 2400 | 2520 | 2 |
| 0.47 | 8.5 × 16.5 × 26.5 | B32923C3474+*** | 1920 | 2000 | 2040 | 2 |
| 0.68 | 10.5 × 16.5 × 26.5 | B32923C3684+*** | 1560 | 1600 | 2160 | 2 |
| 1.0 | 11.0 × 20.5 × 26.5 | B32923C3105+*** ◆ | 1480 | 1400 | 2040 | 2 |
| 1.5 | 12.0 × 22.0 × 26.5 | B32923C3155M*** | — | — | 1800 | 2 |
| 2.2 | 14.5 × 29.5 × 26.5 | B32923C3225+*** | — | — | 1040 | 2 |

◆ Preferred type

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped
(lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped
(lead length 6 – 1 mm)



B32924C/D

X2 / 305 V AC

Ordering codes and packing units (lead spacing 27.5 mm)

| C _R μF | Max. dimensions w × h × l mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./MOQ | Untaped pcs./MOQ | Pins |
|----------------------|------------------------------------|--|-----------------------|------------------|---------------------|------|
| 0.68 | 11.0 × 19.0 × 31.5 | B32924C3684+*** | — | 1400 | 1280 | 2 |
| 1.0 | 11.0 × 19.0 × 31.5 | B32924C3105+*** | — | 1400 | 1280 | 2 |
| 1.5 | 12.5 × 21.5 × 31.5 | B32924C3155+*** ◆ | — | 1200 | 1120 | 2 |
| 2.2 | 14.0 × 24.5 × 31.5 | B32924C3225+*** | — | — | 1040 | 2 |
| 3.3 | 16.0 × 32.0 × 31.5 | B32924D3335K*** | — | — | 880 | 2 |
| 3.3 | 18.0 × 27.5 × 31.5 | B32924C3335M*** | — | — | 800 | 2 |
| 4.7 | 18.0 × 33.0 × 31.5 | B32924C3475M*** | — | — | 800 | 2 |
| 4.7 | 21.0 × 31.0 × 31.5 | B32924D3475K*** | — | — | 720 | 2 |
| 5.6 | 22.0 × 36.5 × 31.5 | B32924C3565+*** | — | — | 784 | 2 |

◆ Preferred type

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped
(lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped
(lead length 6 – 1 mm)

B32926C/D

X2 / 305 V AC



Ordering codes and packing units (lead spacing 37.5 mm)

| C_R μF | Max. dimensions $w \times h \times l$ mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./MOQ | Untaped pcs./MOQ | Pins |
|------------------------|--|--|-----------------------|------------------|---------------------|------|
| 2.2 | 14.0 × 25.0 × 41.5 | B32926C3225+*** | — | — | 1380 | 2 |
| 3.3 | 16.0 × 28.5 × 41.5 | B32926C3335+*** | — | — | 800 | 2 |
| 3.9 | 16.0 × 28.5 × 41.5 | B32926C3395+*** | — | — | 800 | 2 |
| 4.7 | 18.0 × 32.5 × 41.5 | B32926C3475+*** | — | — | 720 | 2 |
| 5.6 | 18.0 × 32.5 × 41.5 | B32926C3565+*** | — | — | 720 | 2 |
| 6.8 | 20.0 × 39.5 × 42.0 | B32926C3685+*** | — | — | 640 | 2 |
| 8.2 | 20.0 × 39.5 × 42.0 | B32926C3825+*** | — | — | 640 | 2 |
| 10 | 28.0 × 42.5 × 42.0 | B32926C3106+*** | — | — | 440 | 2 |
| 15 | 30.0 × 45.0 × 42.0 | B32926C3156M*** | — | — | 400 | 2 |
| 15 | 33.0 × 48.0 × 42.0 | B32926D3156+*** | — | — | 180 | 4 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped
(lead length 3.2 ± 0.3 mm)

000 = Straight terminals, untaped
(lead length 6 – 1 mm)



B32928C/D

X2 / 305 V AC

Ordering codes and packing units (lead spacing 52.5 mm)

| C _R μF | Max. dimensions w × h × l mm | Ordering code (composition see below) | Ammo pack pcs./MOQ | Reel pcs./MOQ | Untaped pcs./MOQ | Pins |
|----------------------|------------------------------------|--|-----------------------|------------------|---------------------|------|
| 20 | 30.0 × 45.0 × 57.5 | B32928C3206+*** | — | — | 280 | 4 |
| 25 | 35.0 × 50.0 × 57.5 | B32928C3256+*** | — | — | 108 | 4 |
| 30 | 35.0 × 50.0 × 57.5 | B32928C3306M*** | — | — | 108 | 4 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

*** = Packaging code:

289 = Straight terminals, Ammo pack

189 = Straight terminals, Reel

003 = Straight terminals, untaped
(lead length 3.2 ±0.3 mm)

000 = Straight terminals, untaped
(lead length 6 – 1 mm)



Technical data

Reference standard: IEC 60384-14:2013. All data given at $T = 20\text{ °C}$, unless otherwise specified.

| | | | | |
|---|--|---|--|--------------------------|
| Max. operating temperature $T_{op,max}$ | +110 °C | | | |
| Dissipation factor $\tan \delta$ (in 10^{-3}) at 20 °C (upper limit values) | at | $C_R \leq 0.1\ \mu\text{F}$ | $0.1\ \mu\text{F} < C_R \leq 2.2\ \mu\text{F}$ | $C_R > 2.2\ \mu\text{F}$ |
| | 1 kHz | 1.0 | 1.0 | 2.0 |
| | 100 kHz | 5.0 | — | — |
| Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$ at 20 °C, rel. humidity $\leq 65\%$ (minimum as-delivered values) | $C_R \leq 0.33\ \mu\text{F}$ | $C_R > 0.33\ \mu\text{F}$ | | |
| | 100 000 M Ω | 30 000 s | | |
| DC test voltage | 2121 V, 2 s ($C \leq 10\ \mu\text{F}$) / 1312 V, 2 s ($C > 10\ \mu\text{F}$) | | | |
| <i>The repetition of this DC voltage test may damage the capacitor. Special care must be taken in case of use several capacitors in a parallel configuration.</i> | | | | |
| Passive flammability category | B | | | |
| Maximum continuous DC voltage V_{DC} | 630 V | | | |
| Maximum continuous AC voltage V_{AC} | 310 V (50/60 Hz) | | | |
| Rated AC voltage (IEC 60384-14) | 305 V (50/60 Hz) | | | |
| Operating AC voltage V_{op} at high temperature | $T_{op} \leq 110\text{ °C}$ | $V_{op} = V_{AC}$ (continuously) | | |
| | $T_{op} \leq 110\text{ °C}$ | $V_{op} = 1.25 \cdot V_{AC}$ (1000 h) | | |
| Damp heat test | 56 days / 40 °C / 93% relative humidity | | | |
| Limit values after damp heat test | Capacitance change $ \Delta C/C $ | $\leq 5\%$ | | |
| | Dissipation factor change $\Delta \tan \delta$ | $\leq 5 \cdot 10^{-3}$ (at 1 kHz) | | |
| | | $\leq 1.0 \cdot 10^{-3}$ (at 10 kHz) | | |
| | Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$ | $\geq 50\%$ of minimum as-delivered values | | |



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X2 / 305 V AC

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/μs.

"k₀" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/μs.

Note:

The values of dV/dt and k₀ provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and k₀ values

| Lead spacing | 10 mm | 15 mm | 22.5 mm | 27.5 mm | 37.5 mm | 52.5 mm |
|--------------------------------------|--------|--------|---------|---------|---------|---------|
| dV/dt in V/μs | 475 | 340 | 170 | 120 | 80 | 50 |
| k ₀ in V ² /μs | 408500 | 292400 | 146200 | 103200 | 68800 | 43200 |

Impedance Z versus frequency f

(typical values)





Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveforms $T_A \leq 90^\circ\text{C}$ and $\Delta ESR < 100\%$ from receipt condition)

Lead spacing 10 mm



Lead spacing 15 mm



Lead spacing 22.5 mm



Lead spacing 27.5 mm





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X2 / 305 V AC

Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveforms $T_A \leq 90^\circ\text{C}$ and $\Delta ESR < 100\%$ from receipt condition)

Lead spacing 37.5 mm



Lead spacing 52.5 mm





Testing and Standards

| Test | Reference | Conditions of test | Performance requirements |
|------------------------------|---|--|---|
| Electrical parameters | IEC 60384-14:2013 | Voltage Proof: Between terminals: $4.3 \times V_R$ (DC), 1 min Terminals and enclosure: $2 V_R + 1500$ V AC Insulation resistance, R_{ins} Capacitance, C Dissipation factor, $\tan \delta$ | Within specified limits |
| Robustness of terminations | IEC 60068-2-21:2006 | Tensile strength (test Ua1) | Capacitance and $\tan \delta$ within specified limits |
| | | Wire diameter | |
| | | $0.5 < d_1 \leq 0.8$ mm | 10 N |
| | | $0.8 < d_1 \leq 1.25$ mm | 20 N |
| Resistance to soldering heat | IEC 60068-2-20:2008, test Tb, method 1A | Solder bath temperature at 260 ± 5 °C, immersion for 10 seconds | $\Delta C/C_0 \leq 5\%$ $\tan \delta$ within specified limits |
| Rapid change of temperature | IEC 60384-14:2013 | T_A = lower category temperature T_B = upper category temperature Five cycles, duration $t = 30$ min. | No visible damage $ \Delta C/C_0 \leq 5\%$ $\tan \delta$ within specified limits |
| Damp heat, steady state | IEC 60384-14:2013 | Test Ca 40 °C / 93% RH / 56 days | No visible damage $ \Delta C/C_0 \leq 5\%$ $ \Delta \tan \delta \leq 0.008$ for $C \leq 1$ μ F $ \Delta \tan \delta \leq 0.005$ for $C > 1$ μ F Voltage proof $R_{ins} \geq 50\%$ of initial limit |
| Impulse test Endurance | IEC 60384-14:2013 | 3 impulses $T_B / 1.25 V_R / 1000$ hours, $1000 V_{RMS}$ for 0.1 s every hour | No visible damage $ \Delta C/C_0 \leq 10\%$ $ \Delta \tan \delta \leq 0.008$ for $C \leq 1$ μ F $ \Delta \tan \delta \leq 0.005$ for $C > 1$ μ F Voltage proof $R_{ins} \geq 50\%$ of initial limit |
| Passive flammability | IEC 60384-14:2013 | Flame applied for a period of time depending on capacitor volume | B |
| Active flammability | IEC 60384-14:2013 | 20 discharges at 2.5 kV + V_R | The cheesecloth shall not burn with a flame |



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Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20:2008, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2:2007, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

| | |
|-------------------------|---|
| Solder bath temperature | 235 ±5 °C |
| Soldering time | 2.0 ±0.5 s |
| Immersion depth | 2.0 +0/−0.5 mm from capacitor body or seating plane |
| Evaluation criteria: | |
| Visual inspection | Wetting of wire surface by new solder ≥90%, free-flowing solder |

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20:2008, test Tb, method 1.

Conditions:

| Series | Solder bath temperature | Soldering time |
|---|-------------------------|--|
| MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing >10 mm) | 260 ±5 °C | 10 ±1 s |
| MFP MKP (lead spacing >7.5 mm) | | |
| MKT boxed (case 2.5 × 6.5 × 7.2 mm) | | 5 ±1 s |
| MKP (lead spacing ≤7.5 mm) | | <4 s |
| MKT uncoated (lead spacing ≤10 mm) insulated (B32559) | | recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559) |



| | |
|----------------------|---|
| Immersion depth | 2.0 +0/−0.5 mm from capacitor body or seating plane |
| Shield | Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder |
| Evaluation criteria: | |
| Visual inspection | No visible damage |
| $\Delta C/C_0$ | 2% for MKT/MKP/MFP 5% for EMI suppression capacitors |
| $\tan \delta$ | As specified in sectional specification |

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings



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The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T_s : Capacitor body maximum temperature at wave soldering

T_p : Capacitor body maximum temperature at pre-heating

KMK1745-A-E



KMK1744-9-E

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Body temperature should follow the description below:

- MKP capacitor
 - During pre-heating: $T_p \leq 110 \text{ }^\circ\text{C}$
 - During soldering: $T_s \leq 120 \text{ }^\circ\text{C}$, $t_s \leq 45 \text{ s}$
- MKT capacitor
 - During pre-heating: $T_p \leq 125 \text{ }^\circ\text{C}$
 - During soldering: $T_s \leq 160 \text{ }^\circ\text{C}$, $t_s \leq 45 \text{ s}$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be $\leq 120 \text{ }^\circ\text{C}$.

One recommended condition for manual soldering is that the tip of the soldering iron should be $< 360 \text{ }^\circ\text{C}$ and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings $\leq 10 \text{ mm}$ (B32560/B32561) the following measures are recommended:

- pre-heating to not more than $110 \text{ }^\circ\text{C}$ in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.



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X2 / 305 V AC

Application note for the different possible X1 / X2 positions

In series with the powerline (i.e. capacitive power supply)

Typical Applications:

- Power meters
- ECUs for white goods and household appliances
- Different sensor applications
- Severe ambient conditions

Basic circuit



Required features

- High capacitance stability over the lifetime
- Narrow tolerances for a controlled current supply

Recommended product series

- B3293* (305 V AC) heavy duty with EN approval for X2 (UL Q1/2010)
- B3265* MKP series
standard MKP capacitor without safety approvals
- B3267*L MKP series
standard MKP capacitor without safety approvals
- B3292*H/J (305 V AC), severe ambient condition, approved as X2

In parallel with the powerline

Typical Applications:

Standard X2 are used parallel over the mains for reducing electromagnetic interferences coming from the grid. For such purposes they must meet the applicable EMC directives and standards.

Basic circuit



Required features

- Standard safety approvals (ENEC, UL, CSA, CQC)
- High pulse load capability
- Withstand surge voltages

Recommended product series

- B3292*C/D (305 V AC)
standard series, approved as X2
- B3291* (330 V AC), approved as X1
- B3291* (530 V AC), approved as X1
- B3291* (550 V AC), approved as X1
- B3292*H/J (305 V AC), severe ambient condition, approved as X2



Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

| Topic | Safety information | Reference chapter "General technical information" |
|-------------------------|---|--|
| Storage conditions | Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions. | 4.5 "Storage conditions" |
| Flammability | Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials. | 5.3 "Flammability" |
| Resistance to vibration | Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics". | 5.2 "Resistance to vibration" |



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| Topic | Safety information | Reference chapter "Mounting guidelines" |
|--|---|--|
| Soldering | Do not exceed the specified time or temperature limits during soldering. | 1 "Soldering" |
| Cleaning | Use only suitable solvents for cleaning capacitors. | 2 "Cleaning" |
| Embedding of capacitors in finished assemblies | When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types! | 3 "Embedding of capacitors in finished assemblies" |

Design of our capacitors

Our EMI capacitors use polypropylene (PP) film metalized with a thin layer of Zinc (Zn). The following key points have made this design suitable to IEC/UL testing, holding a minimum size.

- Overvoltage AC capability with very high temperature Endurance test of IEC 60384-14:2013 (4th edition) / UL 60384-14:2014 (2nd edition) must be performed at $1.25 \times V_R$ at maximum temperature, during 1000 hours, with a capacitance drift less than 10%.
- Higher breakdown voltage withstanding if compared to other film metallizations, like Aluminum. IEC 60384-14:2013 (4th edition) / UL 60384-14:2014 (2nd edition) establishes high voltage tests performed at $4.3 \times V_R$ – 1 minute, impulse testing at 2500 V for C = 1 μ F and active flammability tests.
- Damp heat steady state: 40 °C/ 93% RH / 56 days. (without voltage or current load)

Effect of humidity on capacitance stability

Long contact of a film capacitor with humidity can produce irreversible effects. Direct contact with liquid water or excess exposure to high ambient humidity or dew will eventually remove the film metallization and thus destroy the capacitor. Plastic boxed capacitors must be properly tested in the final application at the worst expected conditions of temperature and humidity in order to check if any parameter drift may provoke a circuit malfunction.

In case of penetration of humidity through the film, the layer of Zinc can be degraded, specially under AC operation (change of polarity), accelerated by the temperature, provoking an increment of the serial resistance of the electrode and eventually a reduction of the capacitance value. For DC operation, the parameter drift is much less.

Plastic boxes and resins can not protect 100% against humidity. Metal enclosures, resin potting or coatings or similar measures by customers in their applications will offer additional protection against humidity penetration.

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the order-

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ing codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.



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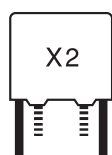
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Symbols and terms

| Symbol | English | German |
|----------------------|---|---|
| α | Heat transfer coefficient | Wärmeübergangszahl |
| α_C | Temperature coefficient of capacitance | Temperaturkoeffizient der Kapazität |
| A | Capacitor surface area | Kondensatoroberfläche |
| β_C | Humidity coefficient of capacitance | Feuchtekoeffizient der Kapazität |
| C | Capacitance | Kapazität |
| C_R | Rated capacitance | Nennkapazität |
| ΔC | Absolute capacitance change | Absolute Kapazitätsänderung |
| $\Delta C/C$ | Relative capacitance change (relative deviation of actual value) | Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert) |
| $\Delta C/C_R$ | Capacitance tolerance (relative deviation from rated capacitance) | Kapazitätstoleranz (relative Abweichung vom Nennwert) |
| dt | Time differential | Differentielle Zeit |
| Δt | Time interval | Zeitintervall |
| ΔT | Absolute temperature change (self-heating) | Absolute Temperaturänderung (Selbsterwärmung) |
| $\Delta \tan \delta$ | Absolute change of dissipation factor | Absolute Änderung des Verlustfaktors |
| ΔV | Absolute voltage change | Absolute Spannungsänderung |
| dV/dt | Time differential of voltage function (rate of voltage rise) | Differentielle Spannungsänderung (Spannungsflankensteilheit) |
| $\Delta V/\Delta t$ | Voltage change per time interval | Spannungsänderung pro Zeitintervall |
| E | Activation energy for diffusion | Aktivierungsenergie zur Diffusion |
| ESL | Self-inductance | Eigeninduktivität |
| ESR | Equivalent series resistance | Ersatz-Serienwiderstand |
| f | Frequency | Frequenz |
| f_1 | Frequency limit for reducing permissible AC voltage due to thermal limits | Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung |
| f_2 | Frequency limit for reducing permissible AC voltage due to current limit | Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung |
| f_r | Resonant frequency | Resonanzfrequenz |
| F_D | Thermal acceleration factor for diffusion | Therm. Beschleunigungsfaktor zur Diffusion |
| F_T | Derating factor | Deratingfaktor |
| i | Current (peak) | Stromspitze |
| I_C | Category current (max. continuous current) | Kategoriestrom (max. Dauerstrom) |



| Symbol | English | German |
|------------------|--|---|
| I_{RMS} | (Sinusoidal) alternating current, root-mean-square value | (Sinusförmiger) Wechselstrom |
| i_z | Capacitance drift | Inkonstanz der Kapazität |
| k_0 | Pulse characteristic | Impuls Kennwert |
| L_S | Series inductance | Serieninduktivität |
| λ | Failure rate | Ausfallrate |
| λ_0 | Constant failure rate during useful service life | Konstante Ausfallrate in der Nutzungsphase |
| λ_{test} | Failure rate, determined by tests | Experimentell ermittelte Ausfallrate |
| P_{diss} | Dissipated power | Abgegebene Verlustleistung |
| P_{gen} | Generated power | Erzeugte Verlustleistung |
| Q | Heat energy | Wärmeenergie |
| ρ | Density of water vapor in air | Dichte von Wasserdampf in Luft |
| R | Universal molar constant for gases | Allg. Molarkonstante für Gas |
| R | Ohmic resistance of discharge circuit | Ohmscher Widerstand des Entladekreises |
| R_i | Internal resistance | Innenwiderstand |
| R_{ins} | Insulation resistance | Isolationswiderstand |
| R_P | Parallel resistance | Parallelwiderstand |
| R_S | Series resistance | Serienwiderstand |
| S | severity (humidity test) | Schärfegrad (Feuchtetest) |
| t | Time | Zeit |
| T | Temperature | Temperatur |
| τ | Time constant | Zeitkonstante |
| $\tan \delta$ | Dissipation factor | Verlustfaktor |
| $\tan \delta_D$ | Dielectric component of dissipation factor | Dielektrischer Anteil des Verlustfaktors |
| $\tan \delta_P$ | Parallel component of dissipation factor | Parallelanteil des Verlustfaktors |
| $\tan \delta_S$ | Series component of dissipation factor | Serienanteil des Verlustfaktors |
| T_A | Temperature of the air surrounding the component | Temperatur der Luft, die das Bauteil umgibt |
| T_{max} | Upper category temperature | Obere Kategorietemperatur |
| T_{min} | Lower category temperature | Untere Kategorietemperatur |
| t_{OL} | Operating life at operating temperature and voltage | Betriebszeit bei Betriebstemperatur und -spannung |
| T_{op} | Operating temperature, $T_A + \Delta T$ | Betriebstemperatur, $T_A + \Delta T$ |
| T_R | Rated temperature | Nenntemperatur |
| T_{ref} | Reference temperature | Referenztemperatur |
| t_{SL} | Reference service life | Referenz-Lebensdauer |



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| Symbol | English | German |
|-------------|--|---|
| V_{AC} | AC voltage | Wechselspannung |
| V_C | Category voltage | Kategorie spannung |
| $V_{C,RMS}$ | Category AC voltage | (Sinusförmige) Kategorie-Wechselspannung |
| V_{CD} | Corona-discharge onset voltage | Teilentlade-Einsatzspannung |
| V_{ch} | Charging voltage | Ladespannung |
| V_{DC} | DC voltage | Gleichspannung |
| V_{FB} | Fly-back capacitor voltage | Spannung (Flyback) |
| V_i | Input voltage | Eingangsspannung |
| V_o | Output voltage | Ausgangsspannung |
| V_{op} | Operating voltage | Betriebsspannung |
| V_p | Peak pulse voltage | Impuls-Spitzen spannung |
| V_{pp} | Peak-to-peak voltage Impedance | Spannungshub |
| V_R | Rated voltage | Nennspannung |
| \hat{V}_R | Amplitude of rated AC voltage | Amplitude der Nenn-Wechselspannung |
| V_{RMS} | (Sinusoidal) alternating voltage, root-mean-square value | (Sinusförmige) Wechselspannung |
| V_{SC} | S-correction voltage | Spannung bei Anwendung "S-correction" |
| V_{sn} | Snubber capacitor voltage | Spannung bei Anwendung "Beschaltung" |
| Z | Impedance | Scheinwiderstand |
| e | Lead spacing | Rastermaß |

Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to our General Terms and Conditions of Supply**.

Important notes

7. **Our manufacturing sites serving the automotive business apply the IATF 16949 standard.** The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements (“CSR”) TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that **only requirements mutually agreed upon can and will be implemented in our Quality Management System.** For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
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